



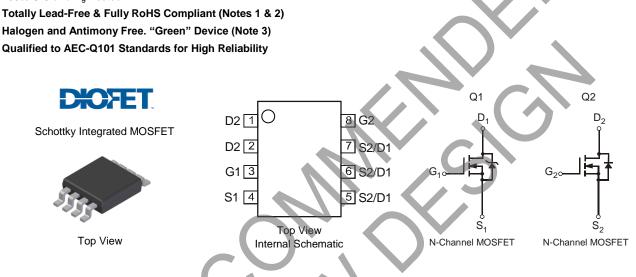
ASYMETRICAL DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- High Density UMOS with Schottky Barrier Diode
- Low Leakage Current at High Temp.
- High Conversion Efficiency
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Utilizes Diodes Incorporated's Monolithic DIOFET Technology to Increase Conversion Efficiency
- 100% UIS and Rg Tested
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Weight: 0.072 grams (Approximate)



Ordering Information (Note 4)

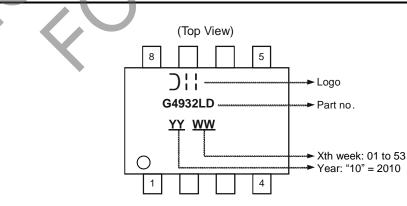
	Part Number	Case	Packaging			
	DMG4932LSD-13	SO-8	2500 / Tape & Reel			
Notes:	otes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					
	2. See https://www.diodes.com/guality/lead-free/ for more information about Diodes Incorrorated's definitions of Halogen- and Antimony-free "Green" and					

des Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings – Q1 (@T_A = +25°C, unless otherwise specified.)

Char	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±12	V		
Continuous Drain Current (Note 5)	Steady State	T _A = +25°C T _A = +85°C	ID	9.5 7.2	A
Pulsed Drain Current (Note 6)	I _{DM}	40	A		
Avalanche Current (Notes 6 & 7)	I _{AR}	13	A		
Repetitive Avalanche Energy (Notes 6 & 7)	E _{AR}	25.4	mJ		

Maximum Ratings – Q2 (@T_A = +25°C, unless otherwise specified.)

Char	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V _{GSS}	±25	V		
Continuous Drain Current (Note 5)Steady $T_A = +25^{\circ}C$ State $T_A = +85^{\circ}C$				9.5 7.5	А
Pulsed Drain Current (Note 6)	Ідм	40	А		
Avalanche Current (Notes 6 & 7)	I _{AR}	13	А		
Repetitive Avalanche Energy (Notes 6 & 7)	E _{AR}	25.4	mJ		

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.19	W
Thermal Resistance, Junction to Ambient $@T_A = +25^{\circ}C$ (Note 5)	R _{0JA}	107	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes: 5. Device mounted on FR-4 PCB with minimum recommended pad layout. The value in any given application depends on the user's specific board design. 6. Repetitive rating, pulse width limited by junction temperature.

7. I_{AR} and E_{AR} ratings are based on low frequency and duty cycles to keep T_{J} = +25°C.

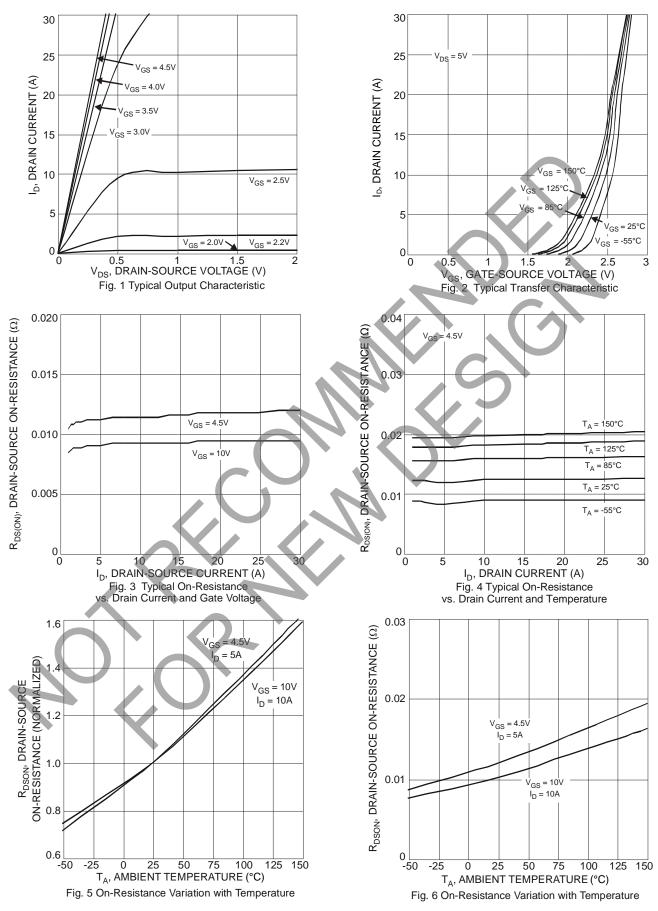
Electrical Characteristics – Q1 (@T_A = +25°C, unless otherwise specified.)

			-			
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						1
Drain-Source Breakdown Voltage	BVDSS	30	—	—	V	$V_{GS} = 0V, I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS		—	0.1	mA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	Igss		—	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	1.0	_	2.4	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance			10	15	mΩ	$V_{GS} = 10V, I_{D} = 9A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	12	18	11152	$V_{GS} = 4.5V, I_D = 7A$
Forward Transfer Admittance	Y _{fs}		14	_	S	$V_{DS} = 10V, I_{D} = 9A$
Diode Forward Voltage	V _{SD}		0.4	0.6	V	$V_{GS} = 0V, I_{S} = 1A$
Maximum Body-Diode + Schottky Continuous Current	I _S	_	_	5	Α	—
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss		1932	_	pF	
Output Capacitance	Coss		154	—	pF	$V_{DS} = 15V, V_{GS} = 0V, f = 1.0MHz$
Reverse Transfer Capacitance	Crss		121	_	pF	
Gate Resistance	Rg		2.68	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (4.5V)	Qq	_	18.1	_	nC	
Total Gate Charge (10V)	Qg	_	42.0	_	nC	
Gate-Source Charge	Q _{gs}	_	4.5	—	nC	$V_{DS} = 15V, V_{GS} = 10V, I_D = 9A$
Gate-Drain Charge	Q _{gd}	_	4.0	_	nC	
Turn-On Delay Time	t _{D(ON)}		6.16	—	ns	
Turn-On Rise Time	t _R		7.22	_	ns	V _{GS} = 10V, V _{DS} = 15V,
Turn-Off Delay Time	t _{D(OFF)}		36.76	—	ns	$R_G = 3\Omega, R_L = 1.7\Omega$
Turn-Off Fall Time	t _F		5.38	_	ns]

Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to production testing.



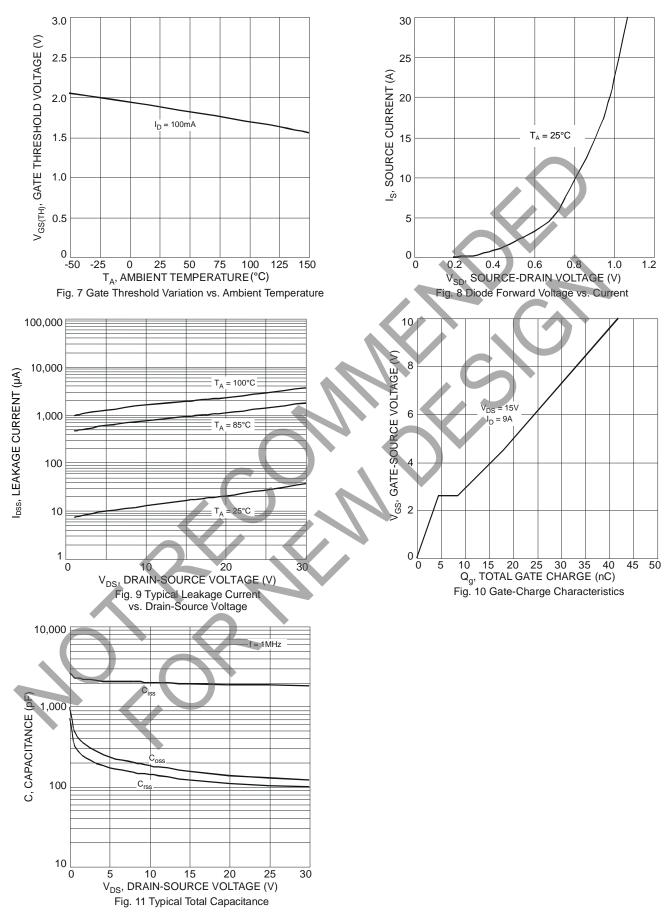
DMG4932LSD



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DMG4932LSD





Electrical Characteristics – Q2 (@T_A = +25°C, unless otherwise specified.)

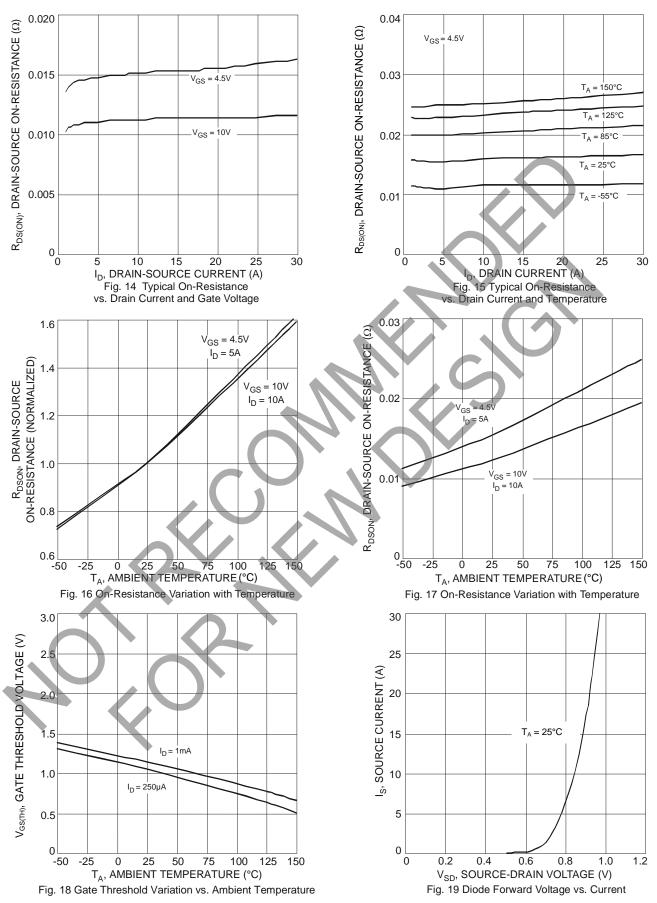
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	30			V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1	μA	$V_{DS} = 30V, V_{GS} = 0V$
Cata Sauraa Laakaga		_	_	+100	nA	$V_{GS} = +25V, V_{DS} = 0V$
Gate-Source Leakage	I _{GSS}		_	-800	nA	$V_{GS} = -25V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	1.0		2.3	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance			12	15.8	15.8 23 mΩ	$V_{GS} = 10V, I_D = 9A$
	R _{DS(ON)}	_	16	23		$V_{GS} = 4.5 V, I_D = 7 A$
Forward Transfer Admittance	Y _{fs}		8	_	S	$V_{DS} = 10V, I_{D} = 9A$
Diode Forward Voltage	V _{SD}	_	0.65	1.0	V	$V_{GS} = 0V, I_S = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	675	—	pF	
Output Capacitance	Coss		98		pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	90		pF	
Gate Resistance	Rg	—	1.6		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (4.5V)	Qq	_	7.8		nC	
Total Gate Charge (10V)	Qq	_	16.0	—	nC	
Gate-Source Charge	Q _{gs}	—	1.9	-	nC	$V_{DS} = 15V, V_{GS} = 10V, I_D = 9A$
Gate-Drain Charge	Q _{ad}		2.6	_	nC	
Turn-On Delay Time	t _{D(ON)}	—	5.05	—	ns	
Turn-On Rise Time	t _R		9.21		ns	V _{GS} = 10V, V _{DS} = 15V,
Turn-Off Delay Time	t _{D(OFF)}	—	20.76		ns	$R_G = 3\Omega, R_L = 1.7\Omega$
Turn-Off Fall Time	t⊧		4.94	_	ns	1

Notes: 8. Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to production testing.

30 30 V_{GS} 25 GS $V_{DS} = 5V$ 25 **DRAIN CURRENT (A)** I_D, DRAIN CURRENT (A) 20 20 V_{GS} = 3.0V 15 15 V_{GS} = 150°C 10 10 $V_{GS} = 2.5V$ = 125° V_{GS} ĉ V_{GS} = 85°0 5 5 $V_{GS} = 25^{\circ}C^{-}$ V_{GS} = 2.2V V_{GS}=[']-55°C V_{GS} = 2.0V 0 0 $\begin{array}{cccc} 0.5 & 1 & 1.5 & 2 & 2.5 \\ V_{GS}, \text{GATE-SOURCE VOLTAGE (V)} \\ \text{Fig. 13 Typical Transfer Characteristic} \end{array}$ 0.5 1 1.5 V_{DS}, DRAIN-SOURCE VOLTAGE (V) 0 2 0 3 Fig. 12 Typical Output Characteristic



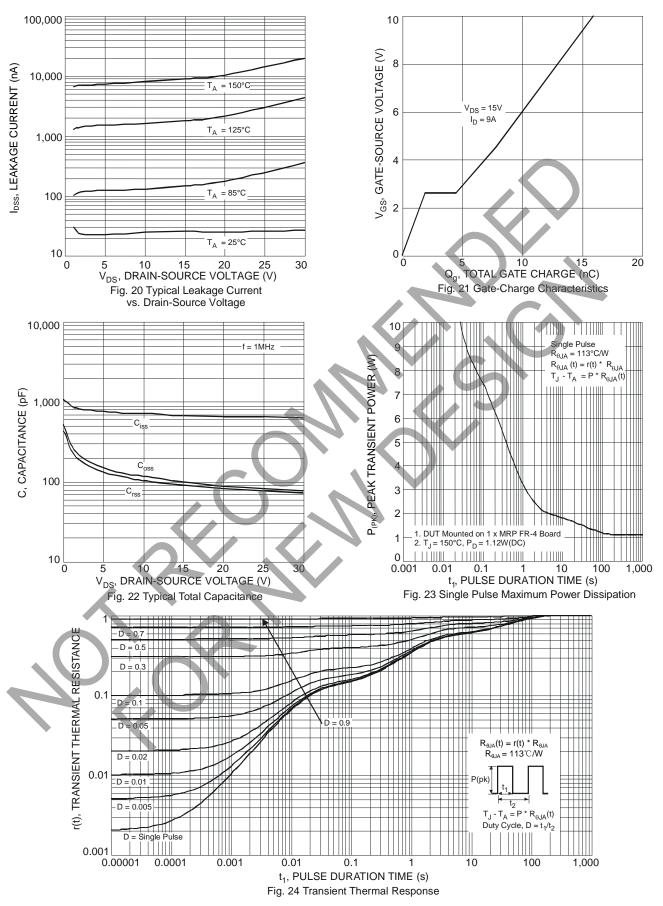
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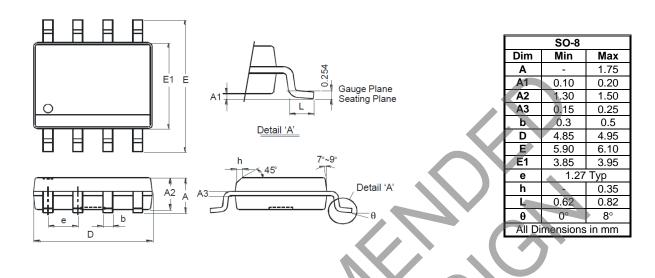




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

		SO-8	Y
	→ [×] ⊭- • • •	N	
	+		
20			

Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27



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